GSE050LB1D5F

ESD Protection Diode

Product Description

It is designed to protect sensitive electronics from damage due to electrostatic discharge (ESD) and other transient events.

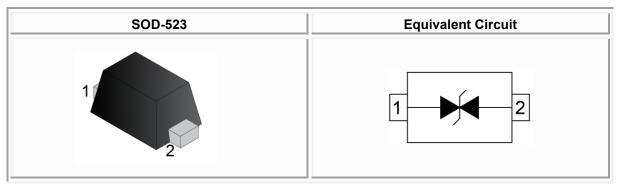
Features

- Operating Voltage: 5V.
- IEC61000-4-2(ESD) ±30kV (Air)
- IEC61000-4-2(ESD) ±30kV (Contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns).
- IEC61000-4-5(Lighting) 7A (8/20µs)

Mechanical Data

- SOD-523. Package
- RoHS Compliant and Halogen Free

Package and Pin Assignment





Ordering and Marking Information

GS P/N	Package	Marking	Quantity / Reel
GSE050LB1D5F	SOD-523	3 5XB 5,00	
GSE050LB1D5F - Product Code: GSE050LB1	F - Package Code: - Green Level: D5 for SOD-523 F for RoHS Compliant and Halogen Free		
	Marking	Information	
5XB	- Product Code 5XB	9 :	

Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
P _{PP}	Peak Pulse Power (t _P =8/20μs)	84	W
IPP	Peak Pulse Current (t⊳=8/20µs)	7	Α
	ESD Per IEC61000-4-2 (Air)	±30	KV
VESD	ESD Per IEC61000-4-2 (Contact)	±30	KV
TJ	Operating Junction Temperature Range	-55 to +125	°C
Tstg	Storage Temperature Range	-55 to +150	°C
TL	Lead Soldering Temperature	260 (10 sec.)	°C

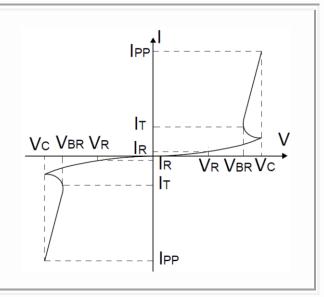


Electrical Characteristics (T_A=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RWM}	Reverse Working Voltage	-			5	V
V _{BR}	Reverse Breakdown Voltage	I _T = 1mA	5.5			V
I _R	Reverse Leakage Current	V _{RWM} =5V			0.1	μA
\	V _C Clamping Voltage	І _{РР} =1А (8/20µs)		7	8	V
Vc		І _{РР} =7А (8/20µs)		10	12	V
CJ	Junction Capacitance	V _R =0V, f=1MHz		10	15	pF

Electrical Parameters

Symbol	Parameter	
Ірр	Reverse Peak Pulse Current	
Vc	Clamping Voltage @ IPP	
V _{RWM}	Reverse Stand-Off Voltage	
l _R	Reverse Leakage Current @ VRWM	
V _{BR}	Breakdown Voltage @ I⊤	
Ι _Τ	Test Current	





Typical Characteristics (T_A=25° unless otherwise specified)

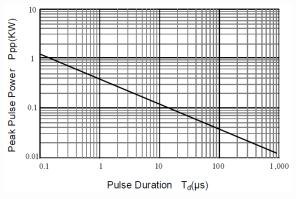
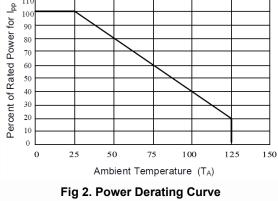


Fig 1. Peak Pulse Power vs. Pulse Time



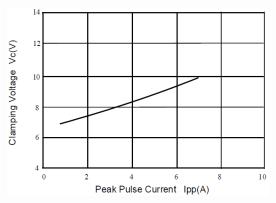


Fig 3. Clamping Voltage vs. Peak Pulse Current

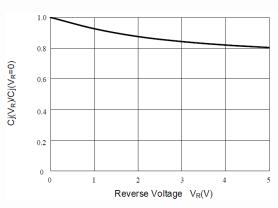


Fig 4. Junction Capacitance vs. Reverse Voltage

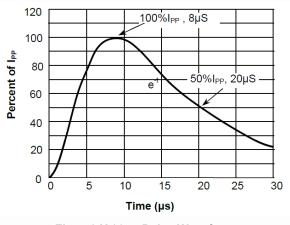


Fig 5. 8 X 20µs Pulse Waveform

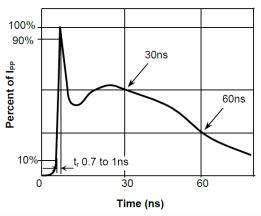
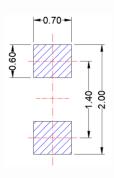


Fig 6. ESD(IEC61000-4-2) Pulse Waveform

SOD-523

Package Dimension

Recommended Land Pattern



Unit:mm

	Dimensions				
Currele el	Millimeters		Inches		
Symbol	MIN	MAX	MIN	MAX	
Α	0.50	0.77	0.020	0.030	
b	0.25	0.40	0.010	0.016	
С	0.07	0.20	0.003	0.008	
D	0.70	0.90	0.028	0.035	
Е	1.50	1.70	0.059	0.067	
E1	1.10	1.30	0.043	0.051	
L	0.20 REF.		0.008 REF		

NOTE:

Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



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